

### Overview

#### HP Elite Dragonfly Notebook PC



1. Internal Microphones
2. IR Camera LEDs
3. Webcam and IR Camera
4. Privacy Camera Shutter
5. Webcam LED

#### Left

6. Glass Clickpad
7. WWAN SIM (Nano)
8. Nano Security Lock Slot (Lock sold separately)
9. Power Button
10. USB 3.1 Gen 1 Charging Port

**NOTE:** All units have a SIM card slot and icon but units that do not support WWAN are shipped with a non-removable SIM slot plug

### Overview



1. HDMI port (Cable not included)
2. Audio Combo Jack
3. USB Type-C™ with Thunderbolt™

#### Right

4. USB Type-C™ with Thunderbolt™
5. Touch Fingerprint Sensor (select models)

### Overview

#### AT A GLANCE

- Precision Machined CNC Mg Unibody with Narrow borders, a chassis that is .63 inches (1.61 cm) thin and with a starting weight of 2.2 lbs. (1 Kg)<sup>1</sup>
- A 360° convertible notebook with 4 usage modes
- Integrated HP Privacy Camera, with a physical shutter to protect from malicious surveillance
- Choice of 8th Generation Intel® Core™ i7, i5 and i3 processors
- Display choices include 33.78 cm (13.3") diagonal IPS FHD touch screen or UHD HDR-400 touch screen. Brightness choices up to 1000 Nits. Get added protection in open or public places with the optional HP Sure View Gen3 integrated privacy screen<sup>2</sup>
- Ultimate connectivity with 4G/LTE WWAN, WLAN, USB Type-C™, USB Type-A, HDMI and Thunderbolt™ Docking
- Engage teams, clients, and vendors with the crystal-clear audio by Bang & Olufsen and the high-performance HP Premium Collaboration Keyboard
- The updated optional HP Rechargeable Active Pen G3
- Never forget your password with your choice of simple authentication methods, including the IR camera for face recognition and Touch Fingerprint Sensor for Windows Hello
- Choice of solid state drives up to 2 TB
- DDR3 Memory up to 16 GB
- Up to 24 hours 30 mins of battery life (FHD, 4-cell 56 WHr battery) and Up to 14 hours of battery life (UHD, 4-cell 56 WHr battery)<sup>3</sup>
- Preinstalled with Windows 10 versions or FreeDOS
- Undergoes 19 MIL-STD 810g tests<sup>4</sup>
- Instant on/instant off with Modern Connected Standby

1. Starting weight less than 1kg is only available in certain configurations.

2. Touch-enabled display and Sure View privacy panel will lower actual brightness.

3. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <http://www.bapco.com> for additional details

4. MIL-STD-810G testing is conducted on all HP EliteBook products. Testing is not intended to demonstrate fitness of U.S. Department of Defense (DoD) contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack

**NOTE: See important legal disclosures for all listed specs in their respective features sections.**

### Technical Specifications

#### PRODUCT NAME

HP Elite Dragonfly Notebook PC

#### OPERATING SYSTEM

|                     |   |
|---------------------|---|
| <b>Preinstalled</b> | Windows 10 Pro 64 <sup>1</sup><br>Windows 10 Pro 64 (National Academic License) <sup>2</sup><br>Windows 10 Home 64 <sup>1</sup><br>Windows 10 Home Single Language 64<br>Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement) <sup>1</sup><br>FreeDOS |
|---------------------|---|

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com/>.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see <https://aka.ms/ProEducation> for Windows 10 Pro Education feature information.

#### PROCESSORS

Intel® Core™ i7-8665U processor with Intel® UHD Graphics 620 (1.9 GHz base frequency, up to 4.8 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) supports Intel® vPro™ Technology<sup>3,4,5,6,7</sup>

Intel® Core™ i7-8565U processor with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)<sup>3,4,5</sup>

Intel® Core™ i5-8365U processor with Intel® UHD Graphics 620 Graphics (1.6 GHz base frequency, up to 4.1 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores) supports Intel® vPro™ Technology<sup>3,4,5,6,7</sup>

Intel® Core™ i5-8265U processor with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores)<sup>3,4,5</sup>

Intel® Core™ i3-8145U processor with Intel® UHD Graphics 620 (2.1 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 4 MB L3 cache, 2 cores)<sup>3,4,5</sup>

##### Processor Family

8th Generation Intel® Core™ i7 processor (i7-8665U, i7-8565U)<sup>8</sup>

8th Generation Intel® Core™ i5 processor (i5-8365U, i5-8265U)<sup>8</sup>

8th Generation Intel® Core™ i3 processor (i3-8145U)<sup>8</sup>

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <http://www.intel.com/technology/turboboost> for more information.

6. Some functionality of vPro, such as Intel Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro technology is dependent on 3rd party software providers. Compatibility with future "virtual appliances" is yet to be determined.

7. For full Intel® vPro™ functionality, Windows, a vPro supported processor, vPro enabled chipset, vPro enabled WLAN card and discrete TPM 2.0 are required.

8. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

### Technical Specifications

#### CHIPSET

Integrated with processor

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#### GRAPHICS

##### Integrated

Intel® UHD Graphics 620

##### Supports

Support HD Decode, DX12, HDMI 1.4b<sup>8</sup>

8. HD content required to view HD images.

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#### DISPLAY

##### Touch

33.8 cm (13.3") diagonal FHD IPS eDP + PSR BrightView WLED-backlit Ultraslim direct bonded touch screen with Corning® Gorilla® Glass 5, 400 nits, 72% NTSC (1920 x 1080)<sup>8,9,10</sup>

33.8 cm (13.3") diagonal FHD IPS eDP + PSR BrightView WLED-backlit Ultraslim direct bonded touch screen with Corning® Gorilla® Glass 5 and HP Sure View Integrated Privacy Screen, 1000 nits, 72% NTSC (1920 x 1080)<sup>8,9,10, 11,47</sup>

33.8 cm (13.3") diagonal 4K IPS eDP + PSR BrightView WLED-backlit Ultraslim direct bonded touch screen with Corning® Gorilla® Glass 5, 550 nits, 69% NTSC (3840 x 2160)<sup>8,9,10</sup>

##### Displays support

Supports dual display through the dock

##### Display Size (Diagonal)

13.3", 33.8cm (13.3")

8. HD content required to view HD images.

9. Sold separately or as an optional feature.

10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

11. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

47. Touch-enabled display and Sure View privacy panel will lower actual brightness.

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### Technical Specifications

| Dockingstation model    | Total number of supported displays (Including the notebook display) | Max. resolutions supported                       | Dock Connectors                     | Technical limitations   |
|-------------------------|---|--|-------------------------------------|---|
| HP Thunderbolt Dock G2  | 3   | Dual 4K @ 60Hz                                   | 2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode | Dual 4k (4096 x 2160) only with: <ul style="list-style-type: none"> <li>• 1 DP + TB port or</li> <li>• USB-C alt mode + TB port</li> </ul> Dual 4K (3840 x 2160) with any of the DP, TB or USB-C alt mode video ports |
| HP Elite USB-C Dock G4  | 3   | Dual 2K @ 60Hz<br>Single 4K @ 60Hz (3840 x 1440) | 1xHDMI, 2xDP                        |   |
| HP USB-C Universal Dock | 3   | Dual 4K @ 60Hz<br>Single 5K @ 60Hz               | 2xDP                                |   |
| HP USB-C Travel Dock    | 2   | Single 2K @ 60Hz                                 | 1xHDMI, 1xVGA                       | Single external display<br>Only HDMI or VGA at the time   |
| HP USB-C Mini Dock      | 2   | Single 4K @ 30Hz                                 | 1xHDMI, 1xVGA                       | Single external display<br>Only HDMI or VGA at the time   |

### Technical Specifications

#### STORAGE AND DRIVES

##### Primary M.2 Storage

- 128 GB SATA-3 SS TLC<sup>12</sup>
- 256 GB PCIe® NVMe™ SS Value<sup>12</sup>
- 256 GB PCIe® Gen3x4 NVMe™ SS TLC<sup>12</sup>
- 256 GB SATA TLC SED OPAL 2<sup>12</sup>
- 256 GB Intel® PCIe® NVMe™ QLC M.2 SSD with 16 GB Intel® Optane™ memory H10<sup>12,13,14</sup>
- 512 GB PCIe® NVMe™ SS Value<sup>12</sup>
- 512 GB PCIe® Gen3x4 NVMe™ SS TLC<sup>12</sup>
- 512 GB SATA TLC SED OPAL 2<sup>12</sup>
- 512 GB SATA-3 SS TLC FIPS-140-2<sup>12</sup>
- 512 GB Intel® PCIe® NVMe™ QLC M.2 SSD with 32 GB Intel® Optane™ memory H10<sup>12,13,14</sup>
- 1 TB PCIe® Gen3x4 NVMe™ SS TLC<sup>12</sup>
- 2 TB PCIe® Gen3x4 NVMe™ SS TLC<sup>12</sup>

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

13. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® Core™ processor, BIOS version with Intel® Optane™ supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.

14. Intel® Optane™ memory H10 only for Intel® PCIe® NVMe™ QLC M.2 SSD.

#### MEMORY

##### Maximum Memory

16 GB LPDDR3-2133 SDRAM

##### Memory

8 GB LPDDR3-2133 SDRAM

16 GB LPDDR3-2133 SDRAM

##### Memory Slots

Memory soldered down

Supports Dual Channel Memory

System runs at: 2133

### Technical Specifications

#### NETWORKING/COMMUNICATIONS

##### WLAN

Intel® AX200 Wi-Fi 6 (2x2) and Bluetooth® 5 Combo, vPro™<sup>15,47</sup>  
Intel® AX200 Wi-Fi 6 (2x2) and Bluetooth® 5 Combo, non-vPro™<sup>15</sup>

##### WWAN

Intel® XMM™ 7360 LTE-Advanced Cat 9<sup>16</sup>  
Intel® XMM™ 7560 LTE-Advanced Pro Cat 16<sup>17</sup>

##### Miracast

Native Miracast Support<sup>18</sup>

##### Ethernet

No Direct Ethernet Support - Ethernet via HP accessories

15. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.

16. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

17. Gigabit class Category 16 4G LTE module is optional and must be configured at the factory. Module designed for up to 1 Gbps download speeds as carriers deploy 5 carrier aggregation and 100Mhz channel bandwidth, requires activation and separately purchased service contract. Backwards compatible to HSPA 3G technologies. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

18. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.  
47. For full Intel® vPro™ functionality, Windows, a vPro supported processor, vPro enabled chipset, vPro enabled WLAN card and discrete TPM 2.0 are required.

#### AUDIO/MULTIMEDIA

##### Audio

Bang & Olufsen  
4 Premium Stereo Speakers; 1609 x 2pcs, 1338 x 2pcs  
Microphones (Multi Array including World-Facing 3rd Mic)  
4 Discrete Amplifiers

##### Camera

Hybrid HD RGB 720p + IR Camera<sup>8,19</sup>

##### Webcam

IR Camera  
Camera Privacy Shutter

##### Sensors

Accelerometer  
Magnetometer  
Gyroscope  
Ambient light sensor



### Technical Specifications

Hall Sensor

8. HD content required to view HD images.

19. Internet access required.

### KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

#### Keyboard

HP Premium Collaboration Keyboard

Backlit, Spill-resistant, with HP Dura Keys

#### Pointing Device

Glass Clickpad

Microsoft Precision Touchpad Default Gestures Support

#### Function Keys

F1 - Display Switching

F2 - Sure View (blank if not supported)

F3 - Brightness Down

F4 - Brightness up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Kybd Backlight

F10 - NumLock

F11 - Wireless

F12 - Calendar

> Share/Present

> Pick Up/Accept/ Answer/Hold

> Hang Up/Decline/ Reject

> Delete

> FN key lock

#### Hidden Function Keys:

Fn+R = Break

Fn+S = Sys Rq

Fn+C = Scroll Lock

Fn+E = Insert

Fn+W = Pause

### Technical Specifications

#### SOFTWARE AND SECURITY

##### Preinstalled Software

###### BIOS

HP BIOSphere Gen5<sup>20</sup>

HP Drive Lock & Automatic Drive Lock<sup>21</sup>

BIOS Update via Network

Master Boot Record Security

Power On Authentication

Secure Erase<sup>22</sup>

Absolute Persistence Module<sup>23</sup>

Pre-boot Authentication

###### Software

HP Connection Optimizer

HP Image Assistant

HP Hotkey Support

HP JumpStart

HP Support Assistant<sup>24</sup>

HP Noise Cancellation Software

Buy Office (sold separately)

###### Manageability Features

HP Driver Packs<sup>25</sup>

HP System Software Manager (SSM)

HP BIOS Config Utility (BCU)

HP Client Catalog

HP Manageability Integration Kit Gen3<sup>26</sup>

###### Client Security Software

HP Client Security Manager Gen5<sup>27</sup>

HP Power On Authentication

Windows Defender<sup>28</sup>

###### Security Management

Pre-boot Authentication

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)

USB enable/disable (via BIOS)

Power-on password (via BIOS)

Setup password (via BIOS)

Support for chassis padlocks and cable lock devices

HP Sure Click<sup>29</sup>

HP Sure Start Gen5<sup>30</sup>

### Technical Specifications

HP Sure Run Gen2<sup>31</sup>

HP Sure Recover Gen2<sup>32</sup>

HP Sure Sense<sup>33</sup>

HP Sure Admin

20. HP BIOSphere Gen5 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.

21. HP Drive Lock & Automatic Drive Lock is not supported on NVMe drives

22. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

23. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: <http://www.absolute.com/company/legal/agreements/computrace-agreement>. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

24. HP Support Assistant requires Windows and Internet access.

25. HP Driver Packs not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>.

26. HP Manageability Integration Kit can be downloaded from <http://www.hp.com/go/clientmanagement>.

27. HP Client Security Manager Gen5 requires Windows and is available on the select HP Pro and Elite PCs. See product specifications for details.

28. Windows Defender Opt in and internet connection required for updates.

29. HP Sure Click is available on most HP PCs and supports Microsoft® Internet Explorer and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.

30. HP Sure Start Gen5 is available on select HP PCs with Intel processors. See product specifications for availability.

31. HP Sure Run Gen2: See product specifications for availability.

32. HP Sure Recover Gen2: See product specifications for availability. Requires an open, wired network connection. Not available on platforms with multiple internal storage drives. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. HP Sure Recover (Gen1) does not support platforms with Intel® Optane™.

33. HP Sure Sense requires Windows 10. See product specifications for availability. On units with WWAN shipping to China, HP Sure Sense is only available via Softpaq download.

### Technical Specifications

#### POWER

##### Power Supply

HP Smart 65 W USB Type-C™ adapter<sup>34</sup>

Supports HP Fast Charging (Up to 50% in 45 minutes)<sup>35</sup>

##### Primary Battery

HP Long Life 2-cell, 38 Wh Li-ion polymer<sup>36</sup>

HP Long Life 4-cell, 56.2 Wh Li-ion polymer<sup>36</sup>

##### Power Cord

Duckhead power cord (C5NS), 1.0m, Sticker, Premium Black<sup>34</sup>

Power Cord C5 Sticker, Premium 1.0m<sup>34</sup>

##### Battery life

Up to 24 hours 30 mins of battery life (FHD, 4-cell 56 WHr battery)<sup>37</sup>

Up to 14 hours of battery life (UHD, 4-cell 56 WHr battery)<sup>37</sup>

##### Battery Weight

56Whr: Starting at 0.48 lb/.22 Kg

38Whr: Starting at 0.35 lb/.16 Kg

34. Availability may vary by country.

35. Recharges the battery up to 50% within 45 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.

36. Battery is internal and not replaceable by customer. Serviceable by warranty.

37. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <http://www.bapco.com> for additional details.

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#### WEIGHTS & DIMENSIONS

##### Product Weight

Starting at 2.2 lb (Does not include power adapter)<sup>38</sup>

Starting at 0.99 kg (Does not include power adapter)<sup>38</sup>

##### Product Dimensions (w x d x h)

11.98 x 7.78 x 0.63 in

30.43 x 19.75 x 1.61 cm

38. Weight will vary by configuration.

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### Technical Specifications

#### PORTS/SLOTS

##### Ports

- 2 Thunderbolt™ (USB Type-C™ connector, support Power Delivery 3.0)
- 1 USB 3.1 Gen 1 (Charging)
- 1 HDMI 1.4<sup>39</sup>
- 1 External Nano SIM slot for WWAN<sup>40</sup>
- 1 Headphone/Microphone Combo

39. HDMI cable sold separately.

40. SIM slot is not user accessible without WWAN configuration.

#### SERVICE AND SUPPORT

HP Services offers 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to <http://www.hp.com/support/batterywarranty/> for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>.<sup>41</sup>

41. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <http://www.hp.com/go/cpc>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

#### COMPATIBILITY

|                                     |         |
|-------------------------------------|---------|
| HP USB-C Travel Dock                | T0K29AA |
| HP Slim Wireless Keyboard and Mouse | T6L04AA |
| 65W USB-C Power Adapter             | 1HE08AA |
| HP External Portable USB3.0 HDD     | K6A93AA |
| HP Keyed Cable lock                 | TOY14AA |

#### CERTIFICATION AND COMPLIANCE

- ENERGY STAR® certified
- EPEAT® 2019 Gold in U.S.<sup>42</sup>
- Low halogen<sup>43</sup>
- TCO 8.0 Certified

42. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit <http://www.epeat.net> for more information.

43. External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

### Technical Specifications

#### ENVIRONMENTAL & INDUSTRY

|  |  |                     |                     |
|--|--|---------------------|---------------------|
| <b>Eco-Label Certifications &amp; declarations</b>                         | <p>This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:</p> <ul style="list-style-type: none"> <li>• IT ECO declaration</li> <li>• US ENERGY STAR®</li> <li>• EPEAT® Gold registered in the United States. Based on US EPEAT registration according to IEEE 1680.1-2018 EPEAT. Status varies by country. See <a href="http://www.epeat.net">http://www.epeat.net</a> for more information.</li> </ul>  |                     |                     |
| <b>System Configuration</b>  | <p>The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a “Typically Configured Notebook”.</p>   |                     |                     |
| <b>Energy Consumption (in accordance with US ENERGY STAR® test method)</b> | <b>115VAC, 60Hz</b>  | <b>230VAC, 50Hz</b> | <b>100VAC, 50Hz</b> |
| Normal Operation (Short idle)  | 5.92 W   | 6.03 W              | 6.02 W              |
| Normal Operation (Long idle)   | 1.93 W   | 2.04 W              | 1.87 W              |
| Sleep  | 0.49 W   | 0.47 W              | 0.49 W              |
| Off  | 0.30 W   | 0.31 W              | 0.30 W              |
|  | <p>Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.</p> |                     |                     |
| <b>Heat Dissipation*</b>   | <b>115VAC, 60Hz</b>  | <b>230VAC, 50Hz</b> | <b>100VAC, 60Hz</b> |
| Normal Operation (Short idle)  | 20 BTU/hr  | 21 BTU/hr           | 21 BTU/hr           |
| Normal Operation (Long idle)   | 6 BTU/hr   | 7 BTU/hr            | 6 BTU/hr            |
| Sleep  | 1 BTU/hr   | 1 BTU/hr            | 2 BTU/hr            |
| Off  | 1 BTU/hr   | 1 BTU/hr            | 1 BTU/hr            |
|  | <p>Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.</p>  |                     |                     |

### Technical Specifications

| <b>Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)</b> | Sound Power<br>( $L_{WAd}$ , bels)  | Sound Pressure<br>( $L_{pAm}$ , decibels) |       |
|--|---|---|-------|
| Typically Configured – Idle  | 2.6   | 15  |       |
| Fixed Disk – Random writes   | 3.2   | 27  |       |
| Longevity and Upgrading  | <p>This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:</p> <ul style="list-style-type: none"> <li>• 3 USB ports</li> <li>• 1 PC card slot (type I/II)</li> <li>• 1 ExpressCard/54 slot</li> <li>• 1 IEEE 1394 Port</li> <li>• 2 SODIMM memory slots</li> <li>• Optional expansion base docking station</li> <li>• 1 multi-bay II storage port</li> <li>• Interchangeable HDD</li> </ul> <p>Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.</p>   |   |       |
| Batteries  | <p>This battery(s) in this product comply with EU Directive 2006/66/EC</p> <p>Batteries used in the product do not contain:<br/>Mercury greater the 1ppm by weight<br/>Cadmium greater than 20ppm by weight</p> <p>Battery size: CR2032 (coin cell)<br/>Battery type: Lithium</p>   |   |       |
| Additional Information   | <ul style="list-style-type: none"> <li>• This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>• This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.</li> <li>• This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>• This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the &lt;Silver&gt; level, see <a href="http://www.epeat.net">http://www.epeat.net</a></li> <li>• Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>• This product contains 9.8% post-consumer recycled plastic (by wt.)</li> <li>• This product is 95.2% recycle-able when properly disposed of at end of life.</li> </ul> |   |       |
| <b>Packaging Materials</b>   | <b>External:</b>  | PAPER/Corrugated                          | 264 g |
|  | <b>Internal:</b>  | PLASTIC/Polyethylene low density - LDPE   | 14 g  |
|  |   | PLASTIC/Polyethylene Expanded - EPE       | 38 g  |
|  |   | PLASTIC/Polypropylene - PP                | 3 g   |
| <b>Material Usage</b>  | <p>This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at <a href="http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf">http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf</a>):</p> <ul style="list-style-type: none"> <li>• Asbestos</li> <li>• Certain Azo Colorants</li> <li>• Certain Brominated Flame Retardants – may not be used as flame retardants in plastics</li> <li>• Cadmium</li> </ul>   |   |       |

### Technical Specifications

|  |   |
|--|---|
|  | <ul style="list-style-type: none"> <li>• Chlorinated Hydrocarbons</li> <li>• Chlorinated Paraffins</li> <li>• Formaldehyde</li> <li>• Halogenated Diphenyl Methanes</li> <li>• Lead carbonates and sulfates</li> <li>• Lead and Lead compounds</li> <li>• Mercuric Oxide Batteries</li> <li>• Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.</li> <li>• Ozone Depleting Substances</li> <li>• Polybrominated Biphenyls (PBBs)</li> <li>• Polybrominated Biphenyl Ethers (PBBEs)</li> <li>• Polybrominated Biphenyl Oxides (PBBOs)</li> <li>• Polychlorinated Biphenyl (PCB)</li> <li>• Polychlorinated Terphenyls (PCT)</li> <li>• Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.</li> <li>• Radioactive Substances</li> <li>• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul> |
| <b>Packaging Usage</b>                             | <p>HP follows these guidelines to decrease the environmental impact of product packaging:</p> <ul style="list-style-type: none"> <li>• Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>• Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>• Design packaging materials for ease of disassembly.</li> <li>• Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>• Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>• Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>• Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>   |
| <b>End-of-life Management and Recycling</b>        | <p>HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.</p> <p>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.</p>  |
| <b>HP Inc. Corporate Environmental Information</b> | <p>For more information about HP's commitment to the environment:</p> <p>Global Citizenship Report</p> <p><a href="http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html">http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html</a></p> <p>Eco-label certifications</p> <p><a href="http://www8.hp.com/us/en/hp-information/environment/ecolabels.html">http://www8.hp.com/us/en/hp-information/environment/ecolabels.html</a></p> <p>ISO 14001 certificates:</p>   |



### Technical Specifications

|  |   |
|--|---|
|  | <a href="http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf">http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf</a><br>and<br><a href="http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf">http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</a> |
|--|---|

### SYSTEM UNIT

|  |  |  |
|--|--|--|
| <b>Stand-Alone Power Requirements</b> (AC Power) | <b>Nominal Operating Voltage</b>       | AC 15V (Type-C)  |
|  | <b>Average Operating Power</b>         | Win10  |
|  | <b>Integrated Graphics</b>             | Yes, Intel   |
|  | <b>Max Operating Power</b>             | UMA<45 W   |
| <b>Temperature</b>                               | <b>Operating</b>                       | 32° to 95° F (0° to 35° C) (not writing optical)           |
|  | <b>Non-operating</b>                   | 41° to 95° F (5° to 35° C) (writing optical)               |
| <b>Relative Humidity</b>                         | <b>Operating</b>                       | 32° to 95° F (0° to 35° C) (not writing optical)           |
|  | <b>Non-operating</b>                   | 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature |
| <b>Shock</b>                                     | <b>Operating</b>                       | 40 G, 2 ms, half-sine                                      |
|  | <b>Non-operating</b>                   | 240 G, 2 ms, half-sine                                     |
| <b>Random Vibration</b>                          | <b>Operating</b>                       | 0.75 grms  |
|  | <b>Non-operating</b>                   | 1.50 grms  |
| <b>Altitude</b> (unpressurized)                  | <b>Operating</b>                       | -50 to 10,000 ft (-15.24 to 3,048 m)                       |
|  | <b>Non-operating</b>                   | -50 to 40,000 ft (-15.24 to 12,192 m)                      |
| <b>Planned Industry Standard Certifications</b>  | <b>UL</b>                              | Yes  |
|  | <b>CSA</b>                             | Yes  |
|  | <b>FCC Compliance</b>                  | Yes  |
|  | <b>ENERGY STAR®</b>                    | Yes <sup>44</sup>  |
|  | <b>EPEAT®</b>                          | EPEAT® 2019 Gold in U.S. <sup>45</sup>                     |
|  | <b>ICES</b>                            | Yes  |
|  | <b>Australia</b>                       | Yes  |
|  | <b>NZ A-Tick Compliance</b>            | Yes  |
|  | <b>CCC</b>                             | Yes  |
|  | <b>Japan VCCI Compliance</b>           | Yes  |
|  | <b>KC</b>                              | Yes  |
|  | <b>BSMI</b>                            | Yes  |
|  | <b>CE Marking Compliance</b>           | Yes  |
|  | <b>BNCI or BELUS</b>                   | Yes  |
|  | <b>CIT</b>                             | Yes  |
|  | <b>GOST</b>                            | Yes  |
|  | <b>Saudi Arabian Compliance (ICCP)</b> | Yes  |
|  | <b>SABS</b>                            | Yes  |

### Technical Specifications

44. Configurations of the HP Elite Dragonfly Notebook PC that are ENERGY STAR® certified are identified as HP Elite Dragonfly Notebook PC ENERGY STAR on HP websites and on <http://www.energystar.gov>.

45. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit <http://www.epeat.net> for more information.

### DISPLAYS

|  |  |   |
|--|--|---|
| <b>Panel LCD 13.3 inch diagonal<br/>FHD (1920 x 1080) BrightView<br/>WLED UWVA 72% NTSC 400 nits<br/>eDP 1.4+PSR2 bent LP NWBZ</b> | <b>Outline Dimensions (W x H)</b>      | 299.06 x 176.54 mm (max) (FPC folding included) |
|  | <b>Active Area</b>                     | 293.76 x 165.24 mm (typ.)                       |
|  | <b>Weight</b>                          | 175 g (max)                                     |
|  | <b>Diagonal Size</b>                   | 13.3 inch                                       |
|  | <b>Thickness</b>                       | 2.0mm / 3.8mm (PCB) (max)                       |
|  | <b>Interface</b>                       | eDP 1.4   |
|  | <b>Surface Treatment</b>               | BrightView                                      |
|  | <b>Touch Enabled</b>                   | Yes   |
|  | <b>Contrast Ratio</b>                  | 1500:1 (typ.)                                   |
|  | <b>Refresh Rate</b>                    | 60 Hz   |
|  | <b>Brightness</b>                      | 400nits   |
|  | <b>Pixel Resolution</b>                | 1920 x 1080 (FHD)                               |
|  | <b>Format of LCD Pixel Arrangement</b> | RGB Stripe                                      |
|  | <b>Backlight</b>                       | LED   |
|  | <b>Color Gamut Coverage</b>            | 72% of NTSC (sRGB 100%) (typ.)                  |
| <b>Color Depth</b>   | 8 bit                                  |   |
| <b>Viewing Angle</b>   | UWVA 85/85/85/85                       |   |

|   |                                   |   |
|---|-----------------------------------|---|
| <b>Panel LCD 13.3 inch diagonal<br/>UHD (3840 x 2160) BrightView<br/>WLED UWVA HDR-400 sRGB 95%<br/>NTSC cg 550 nits eDP 1.4+PSR2<br/>bent NWBZ</b> | <b>Outline Dimensions (W x H)</b> | 299.06 x 176.54 mm (max) (FPC folding included) |
|   | <b>Active Area</b>                | 293.76 x 165.24 mm (typ.)                       |
|   | <b>Weight</b>                     | 200 g (max)                                     |
|   | <b>Diagonal Size</b>              | 13.3 inch                                       |
|   | <b>Thickness</b>                  | 2.0mm / 3.8mm (PCB) (max)                       |
|   | <b>Interface</b>                  | eDP 1.4   |
|   | <b>Surface Treatment</b>          | BrightView                                      |
|   | <b>Touch Enabled</b>              | Yes   |

### Technical Specifications

|  |   |
|--|---|
| <b>Contrast Ratio</b>                  | 1400:1 (typ.)<br>1000:1 (HDR off) (min) |
| <b>Refresh Rate</b>                    | 60 Hz                                   |
| <b>Brightness</b>                      | 550 nits                                |
| <b>Pixel Resolution</b>                | 3840 x 2160 (UHD)                       |
| <b>Format of LCD Pixel Arrangement</b> | RGB Stripe                              |
| <b>Backlight</b>                       | LED                                     |
| <b>Color Gamut Coverage</b>            | sRGB 95% (min)                          |
| <b>Color Depth</b>                     | 8 bits + 2 FRC                          |
| <b>Viewing Angle</b>                   | UWVA 85/85/85/85                        |

**Panel LCD 13.3 inch diagonal  
FHD (1920 x 1080) BrightView  
WLED UWVA 72% NTSC  
1000 nits eDP 1.4+PSR2 bent  
Privacy NWBZ**

|  |   |
|--|---|
| <b>Outline Dimensions (W x H)</b>      | 299.06 x 177.54 mm (max) (FPC folding included) |
| <b>Active Area</b>                     | 293.76 x 165.24 mm (typ.)                       |
| <b>Weight</b>                          | 195 g (max)                                     |
| <b>Diagonal Size</b>                   | 13.3 inch                                       |
| <b>Thickness</b>                       | 3.8 mm (max)                                    |
| <b>Interface</b>                       | eDP 1.4 + PSR2 (4 lane)                         |
| <b>Surface Treatment</b>               | Bright-view (BV)                                |
| <b>Touch Enabled</b>                   | Yes   |
| <b>Contrast Ratio</b>                  | 2000:1 (typ.)                                   |
| <b>Refresh Rate</b>                    | 60 Hz   |
| <b>Brightness*</b>                     | 1000 nits                                       |
| <b>Pixel Resolution</b>                | 1920 x 1080 (FHD)                               |
| <b>Format of LCD Pixel Arrangement</b> | RGB   |
| <b>Backlight</b>                       | LED   |
| <b>Color Gamut Coverage</b>            | 72% of NTSC                                     |
| <b>Color Depth</b>                     | 8 bits  |
| <b>Viewing Angle</b>                   | UWVA 85/85/85/85                                |

\*Touch-enabled display and Sure View privacy panel will lower actual brightness.

### Technical Specifications

#### STORAGE

|                                      |                                 |  |
|--------------------------------------|---------------------------------|--|
| <b>SSD 128 GB 2280 M2 SATA-3 TLC</b> | <b>Form Factor</b>              | M.2 2280                                 |
|                                      | <b>Capacity</b>                 | 128 GB                                   |
|                                      | <b>NAND Type</b>                | TLC                                      |
|                                      | <b>Height</b>                   | 0.09 in (2.3 mm)                         |
|                                      | <b>Width</b>                    | 0.87 in (22 mm)                          |
|                                      | <b>Weight</b>                   | 0.02 lb (10 g)                           |
|                                      | <b>Interface</b>                | ATA-8, SATA 3.0                          |
|                                      | <b>Maximum Sequential Read</b>  | Around 540 ~ 560 MB/s                    |
|                                      | <b>Maximum Sequential Write</b> | Around 500 ~ 530 MB/s                    |
|                                      | <b>Logical Blocks</b>           | 250,069,680                              |
|                                      | <b>Operating Temperature</b>    | 32° to 158°F (0° to 70°C) [ambient temp] |
|                                      | <b>Features</b>                 | DIPM; TRIM; DEVSLP                       |

|  |                                 |  |
|--|---------------------------------|--|
| <b>SSD 1 TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided</b> | <b>Form Factor</b>              | M.2 2280                                 |
|  | <b>Capacity</b>                 | 1 TB                                     |
|  | <b>NAND Type</b>                | TLC                                      |
|  | <b>Height</b>                   | 0.09 in (2.3 mm)                         |
|  | <b>Width</b>                    | 0.87 in (22 mm)                          |
|  | <b>Weight</b>                   | 0.02 lb (10 g)                           |
|  | <b>Interface</b>                | PCIe NVMe Gen3X4                         |
|  | <b>Maximum Sequential Read</b>  | Up To 2800 MB/s                          |
|  | <b>Maximum Sequential Write</b> | Up To 1600 MB/s                          |
|  | <b>Logical Blocks</b>           | 2,000,409,264                            |
|  | <b>Operating Temperature</b>    | 32° to 158°F (0° to 70°C) [ambient temp] |
|  | <b>Features</b>                 | ATA Security (Option); TRIM; L1.2        |

|  |                                 |                       |
|--|---------------------------------|-----------------------|
| <b>SSD 256 GB 2280 M2 PCIe-3x4 SS NVMe TLC</b> | <b>Form Factor</b>              | M.2 2280              |
|  | <b>Capacity</b>                 | 256 GB                |
|  | <b>NAND Type</b>                | TLC                   |
|  | <b>Height</b>                   | 0.09 in (2.3 mm)      |
|  | <b>Width</b>                    | 0.87 in (22 mm)       |
|  | <b>Weight</b>                   | 0.02 lb (10 g)        |
|  | <b>Interface</b>                | PCIe NVMe Gen3X4      |
|  | <b>Maximum Sequential Read</b>  | 2580 MB/s ~ 2600 MB/s |
|  | <b>Maximum Sequential Write</b> | 900 MB/s ~ 1000 MB/s  |

### Technical Specifications

|                              |  |
|------------------------------|--|
| <b>Logical Blocks</b>        | 500,118,192                              |
| <b>Operating Temperature</b> | 32° to 158°F (0° to 70°C) [ambient temp] |
| <b>Features</b>              | ATA Security (Option); TRIM; L1.2        |

|  |  |  |
|--|--|--|
| <b>SSD 256 GB 2280 M2 SATA-3 Self Encrypted OPAL2 Three Layer Cell</b> | <b>Form Factor</b>                             | M.2 2280                                 |
|  | <b>Capacity</b>                                | 256 GB                                   |
|  | <b>NAND Type</b>                               | TLC                                      |
|  | <b>Height</b>                                  | 0.09 in (2.3 mm)                         |
|  | <b>Width</b>                                   | 0.87 in (22 mm)                          |
|  | <b>Weight</b>                                  | 0.02 lb (10 g)                           |
|  | <b>Interface</b>                               | ATA-8, SATA 3.0                          |
|  | <b>Maximum Sequential Read</b>                 | 530 MB/s~ 560 MB/s                       |
|  | <b>Maximum Sequential Write</b>                | 500 MB/s~ 530 MB/s                       |
|  | <b>Logical Blocks</b>                          | 500,118,192                              |
|  | <b>Operating Temperature</b>                   | 32° to 158°F (0° to 70°C) [ambient temp] |
| <b>Features</b>  | ATA Security; TCG OPAL 2.0; DIPM; TRIM; DEVSLP |  |

|  |  |  |
|--|--|--|
| <b>SSD 2 TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided</b> | <b>Form Factor</b>                             | M.2 2280                                 |
|  | <b>Capacity</b>                                | 2 TB                                     |
|  | <b>NAND Type</b>                               | TLC                                      |
|  | <b>Height</b>                                  | 0.09 in (2.3 mm)                         |
|  | <b>Width</b>                                   | 0.87 in (22 mm)                          |
|  | <b>Weight</b>                                  | 0.02 lb (10 g)                           |
|  | <b>Interface</b>                               | PCIe NVMe Gen3X4                         |
|  | <b>Maximum Sequential Read</b>                 | Up To 3000 MB/s                          |
|  | <b>Maximum Sequential Write</b>                | Up To 2100 MB/s                          |
|  | <b>Logical Blocks</b>                          | 3,907,029,168                            |
|  | <b>Operating Temperature</b>                   | 32° to 158°F (0° to 70°C) [ambient temp] |
| <b>Features</b>  | ATA Security; TCG OPAL 2.0; DIPM; TRIM; DEVSLP |  |

|  |                    |                  |
|--|--------------------|------------------|
| <b>SSD 512 GB 2280 M2 PCIe-3x4 SS NVMe TLC</b> | <b>Form Factor</b> | M.2 2280         |
|  | <b>Capacity</b>    | 512 GB           |
|  | <b>NAND Type</b>   | TLC              |
|  | <b>Height</b>      | 0.09 in (2.3 mm) |
|  | <b>Width</b>       | 0.87 in (22 mm)  |
|  | <b>Weight</b>      | 0.02 lb (10 g)   |
|  | <b>Interface</b>   | PCIe NVMe Gen3X4 |

### Technical Specifications

|                                 |  |
|---------------------------------|--|
| <b>Maximum Sequential Read</b>  | 2800 MB/s~ 2900 MB/s                     |
| <b>Maximum Sequential Write</b> | 1000 MB/s~ 1800 MB/s                     |
| <b>Logical Blocks</b>           | 1,000,215,215                            |
| <b>Operating Temperature</b>    | 32° to 158°F (0° to 70°C) [ambient temp] |
| <b>Features</b>                 | ATA Security (Option); TRIM; L1.2        |

|  |                                 |   |
|--|---------------------------------|---|
| <b>SSD 512 GB 2280 PCIe-3x4 NVMe Self Encrypted OPAL2 Three Layer Cell</b> | <b>Form Factor</b>              | M.2 2280  |
|  | <b>Capacity</b>                 | 512 GB  |
|  | <b>NAND Type</b>                | TLC   |
|  | <b>Height</b>                   | 0.09 in (2.3 mm)                                |
|  | <b>Width</b>                    | 0.87 in (22 mm)                                 |
|  | <b>Weight</b>                   | 0.02 lb (10 g)                                  |
|  | <b>Interface</b>                | PCIe NVMe Gen3X4                                |
|  | <b>Maximum Sequential Read</b>  | 2800 MB/s~ 2900 MB/s                            |
|  | <b>Maximum Sequential Write</b> | 1000 MB/s~ 1800 MB/s                            |
|  | <b>Logical Blocks</b>           | 1,000,215,215                                   |
|  | <b>Operating Temperature</b>    | 32° to 158°F (0° to 70°C) [ambient temp]        |
|  | <b>Features</b>                 | ATA Security (Option); TCG Opal 2.0; TRIM; L1.2 |

|  |                                 |  |
|--|---------------------------------|--|
| <b>SSD 512 GB 2280 PCIe NVMe Value</b> | <b>Form Factor</b>              | M.2 2280                                 |
|  | <b>Capacity</b>                 | 512 GB                                   |
|  | <b>NAND Type</b>                | QLC/TLC                                  |
|  | <b>Height</b>                   | 0.09 in (2.3 mm)                         |
|  | <b>Width</b>                    | 0.87 in (22 mm)                          |
|  | <b>Weight</b>                   | 0.02 lb (10 g)                           |
|  | <b>Interface</b>                | PCIe NVMe                                |
|  | <b>Maximum Sequential Read</b>  | Up To 1700 MB/s                          |
|  | <b>Maximum Sequential Write</b> | Up To 1500 MB/s                          |
|  | <b>Logical Blocks</b>           | 1,000,215,215                            |
|  | <b>Operating Temperature</b>    | 32° to 158°F (0° to 70°C) [ambient temp] |
|  | <b>Features</b>                 | ATA Security; TRIM; L1.2                 |

|  |                    |                  |
|--|--------------------|------------------|
| <b>SSD 256 GB 2280 PCIe NVMe Value</b> | <b>Form Factor</b> | M.2 2280         |
|  | <b>Capacity</b>    | 256 GB           |
|  | <b>NAND Type</b>   | TLC              |
|  | <b>Height</b>      | 0.09 in (2.3 mm) |
|  | <b>Width</b>       | 0.87 in (22 mm)  |
|  | <b>Weight</b>      | 0.02 lb (10 g)   |

### Technical Specifications

|                                 |  |
|---------------------------------|--|
| <b>Interface</b>                | PCIe NVMe                                |
| <b>Maximum Sequential Read</b>  | Up To 1700 MB/s                          |
| <b>Maximum Sequential Write</b> | Up to 1300 MB/s                          |
| <b>Logical Blocks</b>           | 500,118,192                              |
| <b>Operating Temperature</b>    | 32° to 158°F (0° to 70°C) [ambient temp] |
| <b>Features</b>                 | ATA Security, TRIM; L1.2                 |

#### 512 GB 2280 PCIe-3x2x2 NVMe+SSD 32 GB 3D Xpoint

|                                 |  |
|---------------------------------|--|
| <b>Form Factor</b>              | M.2 2280                                 |
| <b>Capacity</b>                 | 512 GB                                   |
| <b>NAND Type</b>                | QLC+3D Xpoint                            |
| <b>Height</b>                   | 0.09 in (2.3 mm)                         |
| <b>Width</b>                    | 0.87 in (22 mm)                          |
| <b>Weight</b>                   | 0.02 lb (10 g)                           |
| <b>Interface</b>                | PCIe NVMe Gen3X2X2                       |
| <b>Maximum Sequential Read</b>  | Up To 2400 MB/s                          |
| <b>Maximum Sequential Write</b> | Up To 1300 MB/s                          |
| <b>Logical Blocks</b>           | 1,000,215,215                            |
| <b>Operating Temperature</b>    | 32° to 158°F (0° to 70°C) [ambient temp] |
| <b>Features</b>                 | ATA Security, TRIM; L1.2                 |

#### 256 GB 2280 PCIe-3x2x2 NVMe+SSD 16 GB 3D Xpoint

|                                 |  |
|---------------------------------|--|
| <b>Form Factor</b>              | M.2 2280                                 |
| <b>Capacity</b>                 | 256 GB                                   |
| <b>NAND Type</b>                | QLC+3D Xpoint                            |
| <b>Height</b>                   | 0.09 in (2.3 mm)                         |
| <b>Width</b>                    | 0.87 in (22 mm)                          |
| <b>Weight</b>                   | 0.02 lb (10 g)                           |
| <b>Interface</b>                | PCIe NVMe Gen3X2X2                       |
| <b>Maximum Sequential Read</b>  | Up To 1450 MB/s                          |
| <b>Maximum Sequential Write</b> | Up To 500 MB/s                           |
| <b>Logical Blocks</b>           | 500,118,192                              |
| <b>Operating Temperature</b>    | 32° to 158°F (0° to 70°C) [ambient temp] |
| <b>Features</b>                 | ATA Security, TRIM; L1.2                 |

1. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

### Technical Specifications

#### NETWORKING/COMMUNICATIONS

|   |   |
|---|---|
| <b>Intel® Wi-Fi 6<sup>4</sup> AX200 and Bluetooth® 5.0 802.11ax (2 x 2) (Supporting gigabit file transfer speeds) vPro™1*</b> | <ul style="list-style-type: none"> <li>IEEE 802.11a</li> <li>IEEE 802.11b</li> <li>IEEE 802.11g</li> <li>IEEE 802.11n</li> <li>IEEE 802.11ac</li> <li>IEEE 802.11ax</li> <li>IEEE 802.11d</li> <li>IEEE 802.11e</li> <li>IEEE 802.11h</li> <li>IEEE 802.11i</li> <li>IEEE 802.11k</li> <li>IEEE 802.11r</li> <li>IEEE 802.11v</li> </ul>  |
| <b>Frequency Band</b>   | <ul style="list-style-type: none"> <li>•802.11b/g/n/ax<br/>2.402 – 2.482 GHz</li> <li>•802.11a/n/ac/ax<br/>4.9 – 4.95 GHz (Japan)</li> <li>5.15 – 5.25 GHz</li> <li>5.25 – 5.35 GHz</li> <li>5.47 – 5.725 GHz</li> <li>5.825 – 5.850 GHz</li> </ul>   |
| <b>Data Rates</b>   | <ul style="list-style-type: none"> <li>•802.11b: 1, 2, 5.5, 11 Mbps</li> <li>•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>•802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>•802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &amp; 160MHz)</li> <li>• 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz &amp; 160MHz)</li> </ul> |
| <b>Modulation</b>   | <p>Direct Sequence Spread Spectrum<br/>OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM</p>  |
| <b>Security<sup>2</sup></b>   | <ul style="list-style-type: none"> <li>•IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>•AES-CCMP: 128 bit in hardware</li> <li>•802.1x authentication</li> <li>•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>•WPA2 certification</li> <li>•IEEE 802.11i</li> <li>•WAPI</li> </ul>  |
| <b>Network Architecture Models</b>  | <p>Ad-hoc (Peer to Peer)<br/>Infrastructure (Access Point Required)</p>   |
| <b>Roaming</b>  | IEEE 802.11 compliant roaming between access points   |
| <b>Output Power</b>   | <ul style="list-style-type: none"> <li>• 802.11b: +18.5dBm minimum</li> <li>• 802.11g: +17.5dBm minimum</li> <li>• 802.11a: +18.5dBm minimum</li> </ul>   |



### Technical Specifications

|   |  |                  |                               |                      |                                |
|---|--|------------------|-------------------------------|----------------------|--------------------------------|
|   | <ul style="list-style-type: none"> <li>• 802.11n HT20(2.4GHz): +15.5dBm minimum</li> <li>• 802.11n HT40(2.4GHz): +14.5dBm minimum</li> <li>• 802.11n HT20(5GHz): +15.5dBm minimum</li> <li>• 802.11n HT40(5GHz): +14.5dBm minimum</li> <li>• 802.11ac VHT80(5GHz): +11.5dBm minimum</li> <li>• 802.11ac VHT160(5GHz): +11.5dBm minimum</li> <li>• 802.11ax HT40(2.4GHz): +10dBm minimum</li> <li>• 802.11ax VHT160(5GHz): +10dBm minimum</li> </ul>  |                  |                               |                      |                                |
| <b>Power Consumption</b>                | <ul style="list-style-type: none"> <li>• Transmit mode 2.0 W</li> <li>• Receive mode 1.6 W</li> <li>• Idle mode (PSP) 180 mW (WLAN Associated)</li> <li>• Idle mode 50 mW (WLAN unassociated)</li> <li>• Connected Standby 10mW</li> <li>• Radio disabled 8 mW</li> </ul>  |                  |                               |                      |                                |
| <b>Power Management</b>                 | ACPI and PCI Express compliant power management<br>802.11 compliant power saving mode  |                  |                               |                      |                                |
| <b>Receiver Sensitivity<sup>3</sup></b> | <ul style="list-style-type: none"> <li>• 802.11b, 1Mbps: -93.5dBm maximum</li> <li>• 802.11b, 11Mbps: -84dBm maximum</li> <li>• 802.11a/g, 6Mbps: -86dBm maximum</li> <li>• 802.11a/g, 54Mbps: -72dBm maximum</li> <li>• 802.11n, MCS07: -67dBm maximum</li> <li>• 802.11n, MCS15: -64dBm maximum</li> <li>• 802.11ac, MCS0: -84dBm maximum</li> <li>• 802.11ac, MCS9: -59dBm maximum</li> <li>• 802.11ax, MCS11(HT40): -59dBm maximum</li> <li>• 802.11ax, MCS11(VHT160): -58.5dBm maximum</li> </ul> |                  |                               |                      |                                |
| <b>Antenna type</b>                     | High efficiency antenna with spatial diversity, mounted in the display enclosure<br><br>Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications  |                  |                               |                      |                                |
| <b>Form Factor</b>                      | PCI-Express M.2 MiniCard   |                  |                               |                      |                                |
| <b>Dimensions</b>                       | <ol style="list-style-type: none"> <li>1. Type 2230: 2.3 x 22.0 x 30.0 mm</li> <li>2. Type 1216: 1.67 x 12.0 x 16.0 mm</li> </ol>  |                  |                               |                      |                                |
| <b>Weight</b>                           | <ol style="list-style-type: none"> <li>1. Type 2230: 2.8 g</li> <li>2. Type 126: 1.3 g</li> </ol>  |                  |                               |                      |                                |
| <b>Operating Voltage</b>                | 3.3 v +/- 9%   |                  |                               |                      |                                |
| <b>Temperature</b>                      | <table border="0"> <tbody> <tr> <td><b>Operating</b></td> <td>14° to 158° F (-10° to 70° C)</td> </tr> <tr> <td><b>Non-operating</b></td> <td>-40° to 176° F (-40° to 80° C)</td> </tr> </tbody> </table>  | <b>Operating</b> | 14° to 158° F (-10° to 70° C) | <b>Non-operating</b> | -40° to 176° F (-40° to 80° C) |
| <b>Operating</b>                        | 14° to 158° F (-10° to 70° C)  |                  |                               |                      |                                |
| <b>Non-operating</b>                    | -40° to 176° F (-40° to 80° C)   |                  |                               |                      |                                |
| <b>Humidity</b>                         | <table border="0"> <tbody> <tr> <td><b>Operating</b></td> <td>10% to 90% (non-condensing)</td> </tr> <tr> <td><b>Non-operating</b></td> <td>5% to 95% (non-condensing)</td> </tr> </tbody> </table>  | <b>Operating</b> | 10% to 90% (non-condensing)   | <b>Non-operating</b> | 5% to 95% (non-condensing)     |
| <b>Operating</b>                        | 10% to 90% (non-condensing)  |                  |                               |                      |                                |
| <b>Non-operating</b>                    | 5% to 95% (non-condensing)   |                  |                               |                      |                                |
| <b>Altitude</b>                         | <table border="0"> <tbody> <tr> <td><b>Operating</b></td> <td>0 to 10,000 ft (3,048 m)</td> </tr> <tr> <td><b>Non-operating</b></td> <td>0 to 50,000 ft (15,240 m)</td> </tr> </tbody> </table>  | <b>Operating</b> | 0 to 10,000 ft (3,048 m)      | <b>Non-operating</b> | 0 to 50,000 ft (15,240 m)      |
| <b>Operating</b>                        | 0 to 10,000 ft (3,048 m)   |                  |                               |                      |                                |
| <b>Non-operating</b>                    | 0 to 50,000 ft (15,240 m)  |                  |                               |                      |                                |
| <b>LED Activity</b>                     | LED Amber – Radio OFF<br>LED OFF – Radio ON  |                  |                               |                      |                                |

### Technical Specifications

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

|  |  |
|--|--|
| <b>Bluetooth Specification</b>         | 4.0/4.1/4.2/5.0/5.1 Compliant  |
| <b>Frequency Band</b>                  | 2402 to 2480 MHz   |
| <b>Number of Available Channels</b>    | Legacy: 0~79 (1 MHz/CH)<br>BLE: 0~39 (2 MHz/CH)  |
| <b>Signaling Data Rate</b>             | Legacy: 3 Mbps signaling data rate <sup>1</sup> 2.17 Mbps<br>BLE: 1 Mbps signaling data rate <sup>1</sup> 0.2 Mbps<br><a href="#">1. Actual throughput may vary.</a>   |
| <b>Transmit Power</b>                  | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels<br>Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)<br>The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.  |
| <b>Power Consumption</b>               | Peak (Tx) 330 mW<br>Peak (Rx) 230 mW<br>Selective Suspend 17 mW  |
| <b>Bluetooth Software Supported</b>    | Microsoft Windows Bluetooth Software   |
| <b>Power Management Certifications</b> | Microsoft Windows ACPI, and USB Bus Support<br>FCC (47 CFR) Part 15C, Section 15.247 & 15.249  |
| <b>Power Management Certifications</b> | ETS 300 328, ETS 300 826<br>Low Voltage Directive IEC950<br>UL, CSA, and CE Mark   |
| <b>Bluetooth Profiles Supported</b>    | BT4.1-ESR 5/6/7 Compliance<br>LE Link Layer Ping<br>LE Dual Mode<br>LE Link Layer<br>LE Low Duty Cycle Directed Advertising<br>LE L2CAP Connection Oriented Channels<br>Train Nudging & Interlaced Scan<br>BT4.2 ESR08 Compliance<br>LE Secure Connection- Basic/Full<br>LE Privacy 1.2 –Link Layer Privacy<br>LE Privacy 1.2 –Extended Scanner Filter Policies<br>LE Data Packet Length Extension<br>FAX Profile (FAX)<br>Basic Imaging Profile (BIP) <sup>2</sup><br>Headset Profile (HSP)<br>Hands Free Profile (HFP)<br>Advanced Audio Distribution Profile (A2DP) |

1. Wireless access point and Internet service is required. Availability of public wireless access point is limited.
2. Check latest software/driver release for updates on supported security features.

### Technical Specifications

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

4. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.

\*For full Intel® vPro™ functionality, Windows, a vPro supported processor, vPro enabled chipset, vPro enabled WLAN card and discrete TPM 2.0 are required. See <http://Intel.com/vpro>.

**Intel® Wi-Fi 6<sup>1</sup> AX200 and Bluetooth 5.0 (802.11ax 2 x 2, non-vPro, supporting gigabit file transfer speeds) non-vPro**

- IEEE 802.11a
  - IEEE 802.11b
  - IEEE 802.11g
  - IEEE 802.11n
  - IEEE 802.11ac
  - IEEE 802.11ax
  - IEEE 802.11d
  - IEEE 802.11e
  - IEEE 802.11h
  - IEEE 802.11i
  - IEEE 802.11k
  - IEEE 802.11r
  - IEEE 802.11v
- Frequency Band**
- 802.11b/g/n/ax  
2.402 – 2.482 GHz
  - 802.11a/n/ac/ax  
4.9 – 4.95 GHz (Japan)  
5.15 – 5.25 GHz  
5.25 – 5.35 GHz  
5.47 – 5.725 GHz  
5.825 – 5.850 GHz
- Data Rates**
- 802.11b: 1, 2, 5.5, 11 Mbps
  - 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
  - 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
  - 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
  - 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz & 160MHz)
  - 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz & 160MHz)
- Modulation**
- Direct Sequence Spread Spectrum  
OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
- Security<sup>2</sup>**
- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
  - AES-CCMP: 128 bit in hardware

### Technical Specifications

|   |  |
|---|--|
|   | <ul style="list-style-type: none"> <li>•802.1x authentication</li> <li>•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>•WPA2 certification</li> <li>•IEEE 802.11i</li> <li>•WAPI</li> </ul>   |
| <b>Network Architecture Models</b>      | Ad-hoc (Peer to Peer)<br>Infrastructure (Access Point Required)  |
| <b>Roaming</b>                          | IEEE 802.11 compliant roaming between access points  |
| <b>Output Power</b>                     | <ul style="list-style-type: none"> <li>• 802.11b: +18.5dBm minimum</li> <li>• 802.11g: +17.5dBm minimum</li> <li>• 802.11a: +18.5dBm minimum</li> <li>• 802.11n HT20(2.4GHz): +15.5dBm minimum</li> <li>• 802.11n HT40(2.4GHz): +14.5dBm minimum</li> <li>• 802.11n HT20(5GHz): +15.5dBm minimum</li> <li>• 802.11n HT40(5GHz): +14.5dBm minimum</li> <li>• 802.11ac VHT80(5GHz): +11.5dBm minimum</li> <li>• 802.11ac VHT160(5GHz): +11.5dBm minimum</li> <li>• 802.11ax HT40(2.4GHz): +10dBm minimum</li> <li>• 802.11ax VHT160(5GHz): +10dBm minimum</li> </ul> |
| <b>Power Consumption</b>                | <ul style="list-style-type: none"> <li>• Transmit mode 2.0 W</li> <li>• Receive mode 1.6 W</li> <li>• Idle mode (PSP) 180 mW (WLAN Associated)</li> <li>• Idle mode 50 mW (WLAN unassociated)</li> <li>• Connected Standby 10mW</li> <li>• Radio disabled 8 mW</li> </ul>  |
| <b>Power Management</b>                 | ACPI compliant power management<br>802.11 compliant power saving mode  |
| <b>Receiver Sensitivity<sup>3</sup></b> | <ul style="list-style-type: none"> <li>•802.11b, 1Mbps: -93.5dBm maximum</li> <li>•802.11b, 11Mbps: -84dBm maximum</li> <li>• 802.11a/g, 6Mbps: -86dBm maximum</li> <li>• 802.11a/g, 54Mbps: -72dBm maximum</li> <li>• 802.11n, MCS07: -67dBm maximum</li> <li>• 802.11n, MCS15: -64dBm maximum</li> <li>• 802.11ac, MCS0: -84dBm maximum</li> <li>• 802.11ac, MCS9: -59dBm maximum</li> <li>•802.11ax, MCS11(HT40): -59dBm maximum</li> <li>•802.11ax, MCS11(VHT160): -58.5dBm maximum</li> </ul>   |
| <b>Antenna type</b>                     | High efficiency antenna with spatial diversity, mounted in the display enclosure   |
|   | Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications  |
| <b>Form Factor</b>                      | PCI-Express M.2 MiniCard   |
| <b>Dimensions</b>                       | <ol style="list-style-type: none"> <li>1. Type 2230: 2.3 x 22.0 x 30.0 mm</li> <li>2. Type 1216: 1.67 x 12.0 x 16.0 mm</li> </ol>  |
| <b>Weight</b>                           | <ol style="list-style-type: none"> <li>1. Type 2230: 2.8 g</li> <li>2. Type 1216: 1.3 g</li> </ol>   |

### Technical Specifications

|                          |   |                                |
|--------------------------|---|--------------------------------|
| <b>Operating Voltage</b> | 3.3v +/- 9%                                 |                                |
| <b>Temperature</b>       | <b>Operating</b>                            | 14° to 158° F (–10° to 70° C)  |
|                          | <b>Non-operating</b>                        | –40° to 176° F (–40° to 80° C) |
| <b>Humidity</b>          | <b>Operating</b>                            | 10% to 90% (non-condensing)    |
|                          | <b>Non-operating</b>                        | 5% to 95% (non-condensing)     |
| <b>Altitude</b>          | <b>Operating</b>                            | 0 to 10,000 ft (3,048 m)       |
|                          | <b>Non-operating</b>                        | 0 to 50,000 ft (15,240 m)      |
| <b>LED Activity</b>      | LED Amber – Radio OFF<br>LED OFF – Radio ON |                                |

### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

|  |   |
|--|---|
| <b>Bluetooth Specification</b>         | 4.0/4.1/4.2/5.0/5.1 Compliant   |
| <b>Frequency Band</b>                  | 2402 to 2480 MHz  |
| <b>Number of Available Channels</b>    | Legacy: 0~79 (1 MHz/CH)<br>BLE: 0~39 (2 MHz/CH)   |
| <b>Signaling Data Rate</b>             | Legacy: 3 Mbps signaling data rate <sup>1</sup> 2.17 Mbps<br>BLE: 1 Mbps signaling data rate <sup>1</sup> 0.2 Mbps<br><a href="#">1. Actual throughput may vary.</a>  |
|  | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels<br>Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)  |
| <b>Transmit Power</b>                  | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.   |
| <b>Power Consumption</b>               | Peak (Tx) 330 mW<br>Peak (Rx) 230 mW<br>Selective Suspend 17 mW   |
| <b>Bluetooth Software Supported</b>    | Microsoft Windows Bluetooth Software  |
| <b>Power Management Certifications</b> | Microsoft Windows ACPI, and USB Bus Support<br>FCC (47 CFR) Part 15C, Section 15.247 & 15.249   |
| <b>Power Management Certifications</b> | ETS 300 328, ETS 300 826<br>Low Voltage Directive IEC950<br>UL, CSA, and CE Mark  |
| <b>Bluetooth Profiles Supported</b>    | BT4.1-ESR 5/6/7 Compliance<br>LE Link Layer Ping<br>LE Dual Mode<br>LE Link Layer<br>LE Low Duty Cycle Directed Advertising<br>LE L2CAP Connection Oriented Channels<br>Train Nudging & Interlaced Scan<br>BT4.2 ESR08 Compliance<br>LE Secure Connection- Basic/Full<br>LE Privacy 1.2 –Link Layer Privacy |

### Technical Specifications

LE Privacy 1.2 –Extended Scanner Filter Policies  
 LE Data Packet Length Extension  
 FAX Profile (FAX)  
 Basic Imaging Profile (BIP)2  
 Headset Profile (HSP)  
 Hands Free Profile (HFP)  
 Advanced Audio Distribution Profile (A2DP)

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.
2. Check latest software/driver release for updates on supported security features.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

|   |  |   |
|---|--|---|
| <b>Intel® XMM™ 7360 LTE-Advanced CAT9<sup>1</sup></b> | <b>Technology/Operating bands</b>              | FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66).<br>TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41).<br>HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz |
|   | <b>Wireless protocol standards</b>             | 3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to 450Mbps; UL 20MHz throughput up to 50Mbps<br>WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification   |
|   | <b>GPS</b>                                     | Standalone, A-GPS (MS-A, MS-B)  |
|   | <b>GPS bands</b>                               | 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz  |
|   | <b>Maximum data rates</b>                      | LTE: 450 Mbps (Download), 50 Mbps (Upload)<br>DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)<br>HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)  |
|   | <b>Maximum output power</b>                    | LTE: 23 dBm<br>HSPA+: 23.5 dBm  |
|   | <b>Maximum power consumption</b>               | LTE: 1,200 mA (peak); 900 mA (average)<br>HSPA+: 1,100 mA (peak); 800 mA (average)  |
|   | <b>Form Factor</b>                             | M.2, 3042-S3 Key B  |
|   | <b>Weight</b>                                  | 5.8 g   |
|   | <b>Dimensions (Length x Width x Thickness)</b> | 42 x 30 x 2.3 mm  |

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

### Technical Specifications

|   |  |   |
|---|--|---|
| <b>Intel® XMM™ 7560 LTE-Advanced Pro DL CAT16<sup>1</sup></b> | <b>Technology/Operating bands</b>              | FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66).<br>TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 5200 (Band 46 RX only)<br>HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz |
|   | <b>Wireless protocol standards</b>             | 3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.7 20MHz throughput up to 75Mbps<br>WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification  |
|   | <b>GPS</b>                                     | Standalone, A-GPS (MS-A, MS-B)  |
|   | <b>GPS bands</b>                               | 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz  |
|   | <b>Maximum data rates</b>                      | LTE: 978 Mbps (Download), 75 Mbps (Upload)<br>DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)<br>HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)  |
|   | <b>Maximum output power</b>                    | LTE: 23 dBm in all band except B41<br>LTE B41 HPUE = 26dBm<br>HSPA+: 23.5 dBm   |
|   | <b>Maximum power consumption</b>               | LTE: 1,200 mA (peak); 900 mA (average)<br>HSPA+: 1,100 mA (peak); 800 mA (average)  |
|   | <b>Form Factor</b>                             | M.2, 3042-S3 Key B  |
|   | <b>Weight</b>                                  | 6 g   |
|   | <b>Dimensions (Length x Width x Thickness)</b> | 42 x 30 x 2.3 mm  |

1. Gigabit class Category 16 4G LTE module is optional and must be configured at the factory. Module designed for up to 1 Gbps download speeds as carriers deploy 5 carrier aggregation and 100Mhz channel bandwidth, requires activation and separately purchased service contract. Backwards compatible to HSPA 3G technologies. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

### Technical Specifications

#### POWER

|   |   |   |
|---|---|---|
| <b>AC Adapter 65 Watt nPFC Slim USB type C Straight 1.8 m</b> | <b>Dimensions</b>   | 88.0 x 53.5 x 21.0 mm   |
|   | <b>Weight</b>   | 220 g +/- 10 g  |
| <b>Output</b>   | <b>Input</b>  | 100 to 240 VAC  |
|   | <b>Input Efficiency</b>   | Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec:<br>5V: 81.5%<br>9V: 86.7%<br>12V: 88.0%<br>15V: 89.0%<br>20V: 89.0% |
|   | <b>Input frequency range</b>  | 48 ~ 63 Hz  |
|   | <b>Input AC current</b>   | Max. 1.7 A at 90 Vac  |
|   | <b>Output power</b>   | 5V/15W<br>9V/27W<br>12V/60W<br>15V/65W<br>20V/65W   |
|   | <b>DC output</b>  | 5V / 9V / 12V / 15V / 20V   |
|   | <b>Hold-up time</b>   | 5ms at 115 Vac input  |
|   | <b>Output current limit</b>   | <8.0A   |
|   | <b>Connector</b>  | USB Type-C  |
|   | <b>Environmental Design</b>   | <b>Operating temperature</b>  |
| <b>Non-operating (storage) temperature</b>                    |   | -4°F to 185°F (-20° to 85°C)  |
| <b>Altitude</b>   |   | 0 to 16,400 ft (0 to 5000m)   |
| <b>Humidity</b>   |   | 20% to 95%  |
| <b>Storage Humidity</b>                                       |   | 10% to 95%  |
| <b>EMI and Safety Certifications</b>                          | CE Mark - full compliance with LVD and EMC directives<br>Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.<br>MTBF - over 200,000 hours at 25°C ambient condition. |   |

|   |                              |  |
|---|------------------------------|--|
| <b>AC Adapter 65 Watt nPFC USB type C Straight 1.8 m C6NS</b> | <b>Dimensions</b>            | 74 x 74 x 28.5 mm  |
|   | <b>Weight</b>                | unit: 245 g +/- 10 g   |
| <b>Output</b>   | <b>Input</b>                 | 100 to 240 VAC   |
|   | <b>Input Efficiency</b>      | 81.5% min at 115 Vac/ 230Vac @ 5V/3A<br>86.7% min at 115 Vac/ 230Vac @ 9V/3A<br>88% min at 115 Vac/ 230Vac @ 10V/5A<br>88% min at 115 Vac/ 230Vac @ 12V/5A<br>89% min at 115 Vac/ 230Vac @ 15V/4.33A<br>89% min at 115 Vac/ 230Vac @ 20V/3.25A |
|   | <b>Input frequency range</b> | 47 ~ 63 Hz   |
|   | <b>Input AC current</b>      | 1.7 A at 90 VAC and maximum load   |
|   | <b>Output power</b>          | 65 W   |
|   | <b>DC output</b>             | 5V/9V/10V/12V/15V/20V  |
|   | <b>Hold-up time</b>          | 5ms at 115 Vac input   |



### Technical Specifications

|  |   |  |
|--|---|--|
| <b>Connector</b>                           | <b>Output current limit</b>   | <8.0A  |
|  | Non-Standard C6   |  |
| <b>Environmental Design</b>                | <b>Operating temperature</b>  | 32°F to 95°F (0° to 35°C)                                    |
|  | <b>Non-operating (storage) temperature</b>  | -4°F to 185°F (-20° to 85°C)                                 |
|  | <b>Altitude</b>   | 0 to 16,400 ft (0 to 5000m)                                  |
|  | <b>Humidity</b>   | 5% to 95%  |
|  | <b>Storage Humidity</b>   | 5% to 95%  |
| <b>Safety Certifications</b>               | CE Mark - full compliance with LVD and EMC directives<br>Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.<br>MTBF - over 100,000 hours at 25°C ambient condition. |  |
| <b>HP 4-cell Long Life Li-Ion (56 WHr)</b> | <b>Dimensions (H x W x L)</b>   | 5.25 x 85.00 x 274.00 mm                                     |
|  | <b>Weight</b>   | 0.259 kg   |
|  | <b>Cells/Type</b>   | 4cell Lithium-Ion Polymer cell / 446872                      |
|  | <b>Energy</b>   | <b>Voltage</b> 8.8 V / 7.7 V                                 |
|  |   | <b>Amp-hour capacity</b> 7.3 Ah / 7.0 Ah                     |
|  |   | <b>Watt-hour capacity</b> 56 Wh                              |
|  | <b>Temperature</b>  | <b>Operating (Charging)</b> 32° to 113° F (0° to 45° C)      |
|  |   | <b>Operating (Discharging)</b> 14° to 122° F (-10° to 60° C) |
|  | <b>Optional Travel Battery Available</b>  | No   |

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|  |  |  |
|--|--|--|
| <b>HP 2-cell Long Life Li-Ion (38 WHr)</b> | <b>Dimensions (H x W x L)</b>            | 5.20 x 79.40 x 274.00  |
|  | <b>Weight</b>                            | 0.16 kg  |
|  | <b>Cells/Type</b>                        | 2cell Lithium-Ion Polymer cell / 4453C2                      |
|  | <b>Energy</b>                            | <b>Voltage</b> 8.8 V / 7.7 V                                 |
|  |  | <b>Amp-hour capacity</b> 4.93 Ah / 4.68 Ah                   |
|  |  | <b>Watt-hour capacity</b> 38 Wh                              |
|  | <b>Temperature</b>                       | <b>Operating (Charging)</b> 32° to 113° F (0° to 45° C)      |
|  |  | <b>Operating (Discharging)</b> 14° to 122° F (-10° to 60° C) |
|  | <b>Optional Travel Battery Available</b> | No   |

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### Technical Specifications

#### **COUNTRY OF ORIGIN**

China

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### Options and Accessories (sold separately and availability may vary by country)

| Type                     | Description   | Part #  |
|--------------------------|---|---------|
| <b>Cases</b>             | HP Executive 14.1 Slim Top load                       | 6KD04AA |
|                          | HP Executive 15.6 Top Load                            | 6KD06AA |
|                          | HP Executive 15.6 Backpack                            | 6KD07AA |
| <b>Docking</b>           | HP Thunderbolt Dock 120W G2                           | 2UK37AA |
|                          | HP Thunderbolt Dock w/Combo Cable G2 (Hook with 230W) | 3TR87AA |
|                          | HP Thunderbolt Dock w/Audio Module                    | 3YE87AA |
|                          | HP Audio Module (Hook base dock required)             | 3AQ21AA |
|                          | HP Thunderbolt Dock 120W Cable                        | 3XB94AA |
|                          | HP Thunderbolt Dock Combo Cable                       | 3XB96AA |
|                          | HP USB-C Dock G4                                      | 3FF69AA |
|                          | HP USB-C Universal Dock                               | 1MK33AA |
|                          | HP USB-C Universal Dock Non Flash                     | 3DV65AA |
|                          | HP USB-C Mini Dock                                    | 1PM64AA |
|                          | HP USB-C Dock G5                                      | 5TW10AA |
|                          | HP USB-C/A Universal Dock G2                          | 5TW13AA |
|                          | HP EliteDisplay E223d Docking monitor                 | 5VT82AA |
|                          | HP EliteDisplay E273d Docking monitor                 | 5WN63AA |
|                          | HP E24d G4 FHD Advanced Docking Monitor               | 6PA50AA |
|                          | HP E27d G4 FHD Advanced Docking Monitor               | 6PA56AA |
| <b>Input/Output</b>      | HP Slim Wireless Keyboard and Mouse                   | T6L04AA |
|                          | HP Slim USB Keyboard and Mouse                        | T6T83AA |
|                          | HP Wireless (Link-5) Keyboard                         | T6U20AA |
|                          | HP USB Essential Keyboard and Mouse                   | H6L29AA |
|                          | HP Conferencing Keyboard                              | K8P74AA |
|                          | HP USB Collaboration Keyboard                         | Z9N38AA |
|                          | HP Wireless Collaboration Keyboard                    | Z9N39AA |
|                          | HP Comfort Grip Wireless Mouse                        | H2L63AA |
|                          | HP X4000b Bluetooth Mouse                             | H3T50AA |
|                          | HP 3-Button USB Laser Mouse                           | H4B81AA |
|                          | HP USB Travel Mouse                                   | G1K28AA |
|                          | HP Ultra Mobile Wireless Mouse                        | H6F25AA |
|                          | HP Slim Bluetooth Mouse                               | F3J92AA |
|                          | HP Wireless Premium Mouse                             | 1JR31AA |
|                          | HP USB Premium Mouse                                  | 1JR32AA |
|                          | HP Elite Presenter Mouse                              | 2CE30AA |
|                          | HP UC Speaker Phone                                   | 4VW02AA |
|                          | HP USB-C to USB-A Hub                                 | Z6A00AA |
|                          | HP USB-C to DP  | N9K78AA |
|                          | HP USB-C to VGA                                       | N9K76AA |
| HP USB-C to RJ45 Adapter | V7W66AA   |         |

### Options and Accessories (sold separately and availability may vary by country)

|                 |                                    |         |
|-----------------|------------------------------------|---------|
|                 | HP HDMI to DVI                     | F5A28AA |
|                 | HP HDMI to VGA                     | H4F02AA |
|                 | HP USB 3.0 to Gigabit Adapter      | N7P47AA |
|                 | HP Elite USB-C Hub                 | 4WX89AA |
|                 | HP USB-C to 4.5mm Adapter          | 4ST73AA |
| <b>Power</b>    | HP 65W USB-C Power Adapter         | 1HE08AA |
|                 | HP 65W USB-C Slim Power Adapter    | 3PN48AA |
|                 | HP 65W USB-C Auto Adapter          | 5TQ76AA |
|                 | HP USB-C Notebook Power Bank       | 2NA10AA |
| <b>Security</b> | HP Nano Keyed Cable Lock           | 1AJ39AA |
|                 | HP Nano Dual-Head Keyed Cable Lock | 1AJ41AA |
|                 | HP Nano Keyed Cable Lock           | 1AJ39AA |
|                 | HP Nano Dual-Head Keyed Cable Lock | 1AJ41AA |
|                 | HP Sure Key Cable Lock             | 6UW42AA |
| <b>UCC</b>      | HP Stereo 3.5mm Headset            | T1A66AA |
|                 | HP Stereo USB Headset              | T1A67AA |
|                 | HP UC Wireless Mono Headset        | W3K08AA |
|                 | HP UC Wireless Duo Headset         | W3K09AA |

### Summary of Changes

| Date of change:   | Version History: |         | Description of change:    |
|-------------------|------------------|---------|---------------------------|
| October 29, 2019  | V1 to V2         | Added   | Environmental Section     |
| November 12, 2019 | V2 to V3         | Updated | Battery Life              |
| November 18, 2019 | V3 to V4         | Updated | Docking section           |
| November 25, 2019 | V4 to V5         | Updated | Panels in display section |
| December 16, 2019 | V5 to V6         | Removed | UltraSlim Docking         |
| December 18, 2019 | V6 to V7         | Updated | At a glance Section       |
| March 2, 2020     | V7 to V8         | Removed | Fingerprint               |
|                   |                  |         |                           |
|                   |                  |         |                           |
|                   |                  |         |                           |
|                   |                  |         |                           |
|                   |                  |         |                           |
|                   |                  |         |                           |

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